

Title (en)
COMPOUNDS WITH SPIROBIFLUORENE-STRUCTURES

Title (de)
VERBINDUNGEN MIT SPIROBIFLUOREN-STRUKTUREN

Title (fr)
COMPOSÉS À STRUCTURES SPIROBIFLUORÈNE

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Application
EP 17710010 A 20170315

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Abstract (en)
[origin: WO2017157983A1] The invention relates to spirobifluorene derivatives which are substituted with pyridine and/or pyrimidine groups, in particular for use in electronic devices. The invention further relates to a method for producing the compounds according to the invention, and to electronic devices comprising the same.

IPC 8 full level
C07D 403/04 (2006.01); **C07D 213/16** (2006.01); **C07D 213/22** (2006.01); **C07D 239/26** (2006.01); **C07D 403/14** (2006.01); **C07D 405/04** (2006.01); **C07D 405/10** (2006.01); **C07D 409/04** (2006.01); **H01L 51/00** (2006.01)

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